



60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
60V	$12m\Omega @ V_{GS} = 10V$	80A
	$18m\Omega @ V_{GS} = 4.5V$	70A

Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AECQ101, supported by a PPAP and is ideal for use in:

- Engine Management Systems
- Body Control Electronics
- DC/DC Converters

Features

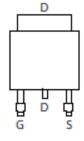
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures more Reliable and Robust End Application
- Low On-Resistance
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

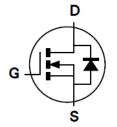
- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Finish Annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.33 grams (Approximate)







Pin Out Top View



Equivalent Circuit

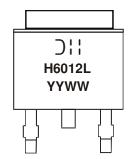
Ordering Information (Note 5)

Part Number	Case	Packaging
DMNH6012LK3Q-13	TO252 (DPAK)	2500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Dil = Manufacturer's Marking
H6012L = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 16 = 2016)
WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V _{DSS}	60	V
Gate-Source Voltage	V_{GSS}	±20	V	
Continuous Drain Current (Note 8), $V_{GS} = 10V$ $T_C = +25^{\circ}C$ $T_C = +100^{\circ}C$		I _D	80 60	Α
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%)		I _{DM}	120	Α
Maximum Continuous Body Diode Forward Current (Note 8)		I _S	80	Α
Avalanche Current, L = 0.1mH (Note 9)	I _{AS}	45	Α	
Avalanche Energy, L = 0.1mH (Note 9)		Eas	100	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

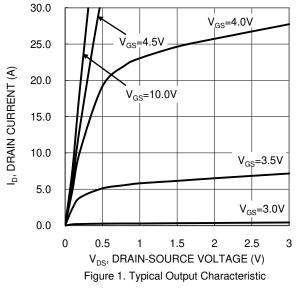
Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)		P_D	2.0	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ heta JA}$	74	°C/W
Total Power Dissipation (Note 7)		P _D	3.8	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	$R_{ heta JA}$	40	°C/W
Thermal Resistance, Junction to Case (Note 8)		$R_{ heta JC}$	1.2	C/VV
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +175	°C

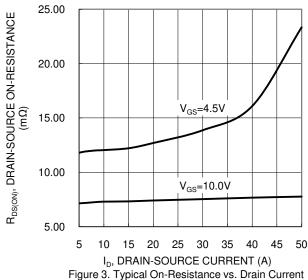
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

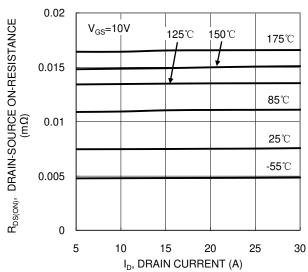
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 10)							
Drain-Source Breakdown Voltage		60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current, T _J = +25°C	I _{DSS}	_	_	1	μΑ	V _{DS} = 60V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 10)							
Gate Threshold Voltage	$V_{GS(TH)}$	1	_	3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	8	12	mΩ	$V_{GS} = 10V, I_D = 25A$	
Static Dialif-Source Off-Nesistance	R _{DS(ON)}	_	10	18	11122	$V_{GS} = 4.5V, I_D = 25A$	
Diode Forward Voltage	V_{SD}	_	0.7	1.2	V	V _{GS} = 0V, I _S = 1.7A	
DYNAMIC CHARACTERISTICS (Note 11)							
Input Capacitance	C _{iss}	1	1926	_	pF	V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	l	330	_	pF		
Reverse Transfer Capacitance	C_{rss}	1	112	_	pF		
Gate Resistance	R_g	_	2.0	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	16.3	_	nC		
Total Gate Charge (V _{GS} = 10V)	Q_g	_	35.2	_	nC	7, 20,4 25,4	
Gate-Source Charge	Q _{gs}	_	7.6	_	nC	$V_{DS} = 30V, I_{D} = 25A$	
Gate-Drain Charge	Q_{gd}	_	6.9	_	nC	1	
Turn-On Delay Time	t _{D(ON)}		6.4	_	ns	$V_{GS} = 10V, V_{DS} = 30V,$ $R_g = 3\Omega, I_D = 25A$	
Turn-On Rise Time	t _R	_	11.9	_	ns		
Turn-Off Delay Time	t _{D(OFF)}		16.5	_	ns		
Turn-Off Fall Time	t _F	_	5	_	ns		
Body Diode Reverse Recovery Time	t _{RR}	1	28	_	ns	I _F = 25A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Q _{RR}	1	23	_	nC	$I_F = 25A$, $di/dt = 100A/\mu s$	

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 8. Thermal resistance from junction to soldering point (on the exposed drain pad).
- I. As and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.



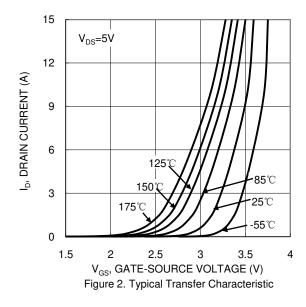


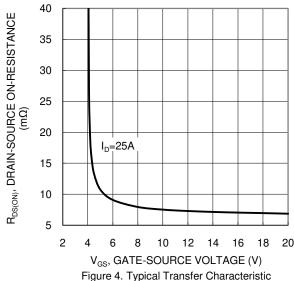




and Gate Voltage

Figure 5. Typical On-Resistance vs. Drain Current and Temperature





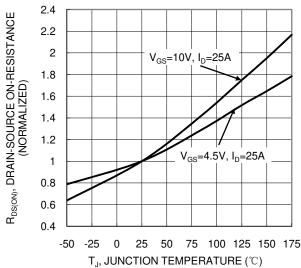


Figure 6. On-Resistance Variation with Temperature



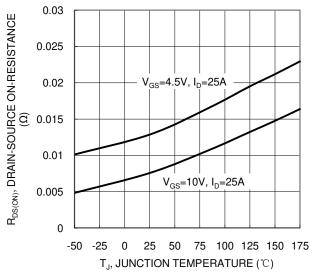


Figure 7. On-Resistance Variation with Temperature

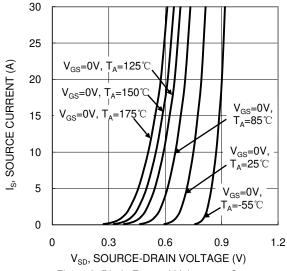
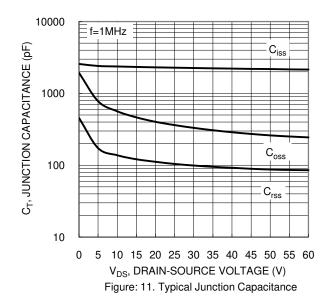


Figure 9. Diode Forward Voltage vs. Current



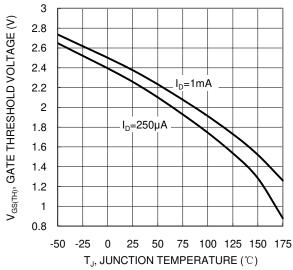
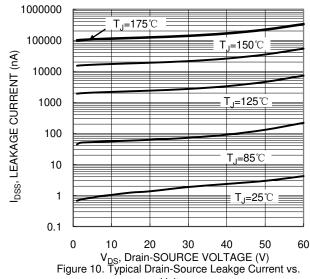


Figure 8. Gate Threshold Variation vs. Junction Temperature



Voltage

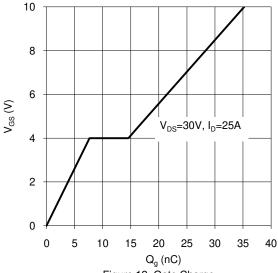
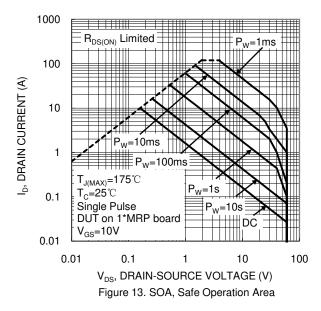
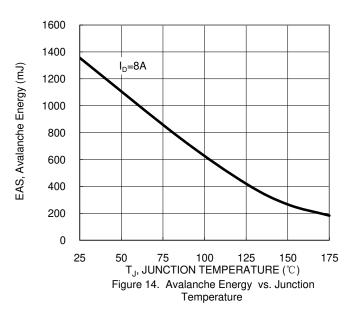
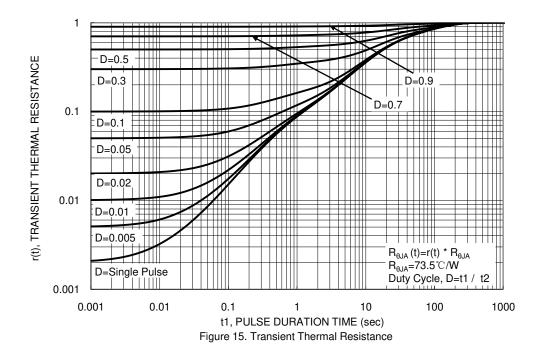


Figure 12. Gate Charge







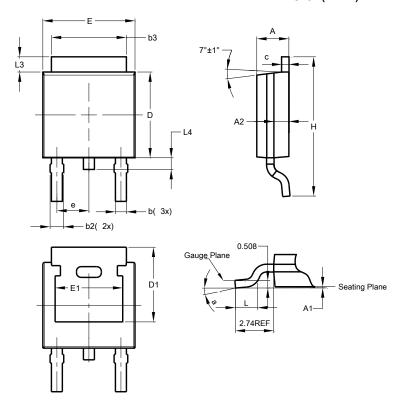




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)



TO252 (DPAK)					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
A 1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
p	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
O	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	-	-		
е	-	-	2.286		
П	6.45	6.70	6.58		
E1	4.32	-	-		
H	9.40	10.41	9.91		
Г	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	-		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)

Dimensions	Value (in mm)		
С	4.572		
X	1.060		
X1	5.632		
Υ	2.600		
Y1	5.700		
Y2	10.700		



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